



Product End-of-Life Disassembly Instructions

Product Category: Networking Equipment

Marketing Name / Model

[List multiple models if applicable.]

ProCurve Switch 5512zl (J8698A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

| Item Description | Notes | Quantity of items included in product |
|--|--|---------------------------------------|
| Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA) | With a surface greater than 10 sq cm 1 backplane PCA, 2 Power distribution board, 2 Power bridging board, 1 EPS board, 1 management line card | 7 |
| Batteries | All types including standard alkaline and lithium coin or button style batteries BR2032 on J8726A module | 1 |
| Mercury-containing components | For example, mercury in lamps, display backlights, scanner lamps, switches, batteries | 0 |
| Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm | Includes background illuminated displays with gas discharge lamps | 0 |
| Cathode Ray Tubes (CRT) | | 0 |
| Capacitors / condensers (Containing PCB/PCT) | | 0 |
| Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height | | 0 |
| External electrical cables and cords | | 0 |
| Gas Discharge Lamps | | 0 |
| Plastics containing Brominated Flame Retardants | | 0 |
| Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner | Include the cartridges, print heads, tubes, vent chambers, and service stations. | 0 |
| Components and waste containing asbestos | | 0 |
| Components, parts and materials containing refractory ceramic fibers | | 0 |
| Components, parts and materials containing radioactive substances | | 0 |

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

| Tool Description | Tool Size (if applicable) |
|-------------------------|---------------------------|
| Torx driver | T-10 |
| Small adjustable wrench | 5mm |
| Wire Cutters | Medium |
| | |

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remove any blank slot cover line card by unfasten 2 screws on each slot cover/line card

Refer to respective line card product disassembly instructions to remove components/materials requiring selective treatment in power supplies and line cards.

2. For management line card J8726A

- Unfasten 2 screws on the expansion line card
- Remove 2 screws and disassemble bulkhead from line card

2. Remove power supply unit(s)/blank cover at rear of chassis

3. For Fan tray

- Unfasten screws on fan tray and pull handle to remove fan tray
- Cut cable ties and disengage connector on LED PCA
- Remove black connectors holding the fans and LED PCA

4. For power shelve

- Remove screws fasten at the back of the chassis and on the backplane
- Remove screws fasten on the 2 Power bridging board (PCA)
- Remove screws fasten on the EPS board (PCA) at the bottom of the power shelve

5. Remove screws fasten on the 2 Power Distribution board (PCA) from the front of the chassis

6. Remove screws fasten on the backplane PCA from the back of the chassis

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

